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### **Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	1232
Number of Logic Elements/Cells	11088
Total RAM Bits	811008
Number of I/O	248
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc2vp7-6fgg456c">https://www.e-xfl.com/product-detail/xilinx/xc2vp7-6fgg456c</a>

**Table 5: Clock Ratios for Various Data Widths**

Fabric Data Width	Frequency Ratio of USRCLK:USRCLK2
1-byte	1:2 <sup>(1)</sup>
2-byte	1:1
4-byte	2:1 <sup>(1)</sup>

**Notes:**

1. Each edge of slower clock must align with falling edge of faster clock.

**FPGA Transmit Interface**

The FPGA can send either one, two, or four characters of data to the transmitter. Each character can be either 8 bits or 10 bits wide. If 8-bit data is applied, the additional inputs become control signals for the 8B/10B encoder. When the 8B/10B encoder is bypassed, the 10-bit character order is generated as follows:

TXCHARDISPMODE[0] (first bit transmitted)  
 TXCHARDISPVAL[0]  
 TXDATA[7:0] (last bit transmitted is TXDATA[0])

**Disparity Control**

The 8B/10B encoder is initialized with a negative running disparity. Unique control allows forcing the current running disparity state.

TXRUNDISP signals its current running disparity. This may be useful in those cases where there is a need to manipulate the initial running disparity value.

Bits TXCHARDISPMODE and TXCHARDISPVAL control the generation of running disparity before each byte.

For example, the transceiver can generate the sequence

K28.5+ K28.5+ K28.5- K28.5-  
 or  
 K28.5- K28.5- K28.5+ K28.5+

by specifying inverted running disparity for the second and fourth bytes.

**Transmit FIFO**

Proper operation of the circuit is only possible if the FPGA clock (TXUSRCLK) is frequency-locked to the reference clock (REFCLK). Phase variations up to one clock cycle are allowable. The FIFO has a depth of four. Overflow or underflow conditions are detected and signaled at the interface. Bypassing of this FIFO is programmable.

**8B/10B Encoder**

Note: In the RocketIO transceiver, the most-significant byte is sent first; in the RocketIO X transceiver, the least-significant byte is sent first.

A bypassable 8B/10B encoder is included. The encoder uses the same 256 data characters and 12 control characters used by Gigabit Ethernet, Fibre Channel, and InfiniBand.

The encoder accepts 8 bits of data along with a K-character signal for a total of 9 bits per character applied, and generates a 10 bit character for transmission. If the K-character signal is High, the data is encoded into one of the twelve possible K-characters available in the 8B/10B code. If the K-character input is Low, the 8 bits are encoded as standard data. If the K-character input is High, and a user applies other than one of the twelve possible combinations, TXKERR indicates the error.

**8B/10B Decoder**

Note: In the RocketIO transceiver, the most-significant byte is sent first; in the RocketIO X transceiver, the least-significant byte is sent first.

An optional 8B/10B decoder is included. A programmable option allows the decoder to be bypassed. When the 8B/10B decoder is bypassed, the 10-bit character order is, for example,

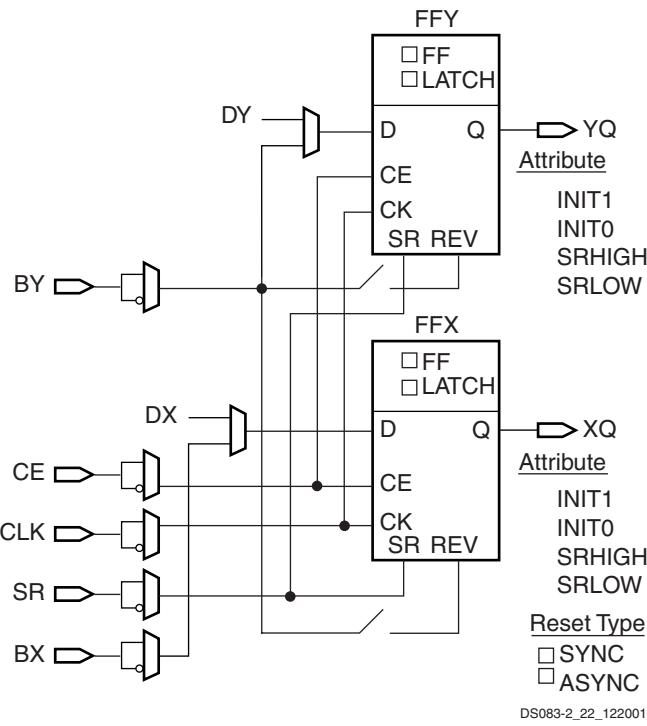
RXCHARISK[0]	(first bit received)
RXRUNDISP[0]	
RXDATA[7:0]	(last bit received is RXDATA[0])

The decoder uses the same table that is used for Gigabit Ethernet, Fibre Channel, and InfiniBand. In addition to decoding all data and K-characters, the decoder has several extra features. The decoder separately detects both "disparity errors" and "out-of-band" errors. A disparity error is the reception of 10-bit character that exists within the 8B/10B table but has an incorrect disparity. An out-of-band error is the reception of a 10-bit character that does not exist within the 8B/10B table. It is possible to obtain an out-of-band error without having a disparity error. The proper disparity is always computed for both legal and illegal characters. The current running disparity is available at the RXRUNDISP signal.

The 8B/10B decoder performs a unique operation if out-of-band data is detected. If out-of-band data is detected, the decoder signals the error and passes the illegal 10-bits through and places them on the outputs. This can be used for debugging purposes if desired.

The decoder also signals the reception of one of the 12 valid K-characters. In addition, a programmable comma detect is included. The comma detect signal registers a comma on the receipt of any comma+, comma-, or both. Since the comma is defined as a 7-bit character, this includes several out-of-band characters. Another option allows the decoder to detect only the three defined commas (K28.1, K28.5, and K28.7) as comma+, comma-, or both. In total, there are six possible options, three for valid commas and three for "any comma."

Note that all bytes (1, 2, or 4) at the RX FPGA interface each have their own individual 8B/10B indicators (K-character, disparity error, out-of-band error, current running disparity, and comma detect).



**Figure 35: Register / Latch Configuration in a Slice**

The set and reset functionality of a register or a latch can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset has precedence over a set, and an asynchronous clear has precedence over a preset.

### Distributed SelectRAM+ Memory

Each function generator (LUT) can implement a 16 x 1-bit RAM resource called a distributed SelectRAM+ element. SelectRAM+ elements are configurable within a CLB to implement the following:

- Single-Port 16 x 8-bit RAM
- Single-Port 32 x 4-bit RAM
- Single-Port 64 x 2-bit RAM

- Single-Port 128 x 1-bit RAM
- Dual-Port 16 x 4-bit RAM
- Dual-Port 32 x 2-bit RAM
- Dual-Port 64 x 1-bit RAM

Distributed SelectRAM+ memory modules are synchronous (write) resources. The combinatorial read access time is extremely fast, while the synchronous write simplifies high-speed designs. A synchronous read can be implemented with a storage element in the same slice. The distributed SelectRAM+ memory and the storage element share the same clock input. A Write Enable (WE) input is active High, and is driven by the SR input.

**Table 16** shows the number of LUTs (2 per slice) occupied by each distributed SelectRAM+ configuration.

**Table 16: Distributed SelectRAM+ Configurations**

RAM	Number of LUTs
16 x 1S	1
16 x 1D	2
32 x 1S	2
32 x 1D	4
64 x 1S	4
64 x 1D	8
128 x 1S	8

#### Notes:

1. S = single-port configuration; D = dual-port configuration

For single-port configurations, distributed SelectRAM+ memory has one address port for synchronous writes and asynchronous reads.

For dual-port configurations, distributed SelectRAM+ memory has one port for synchronous writes and asynchronous reads and another port for asynchronous reads. The function generator (LUT) has separated read address inputs (A1, A2, A3, A4) and write address inputs (WG1/WF1, WG2/WF2, WG3/WF3, WG4/WF4).

In single-port mode, read and write addresses share the same address bus. In dual-port mode, one function generator (R/W port) is connected with shared read and write addresses. The second function generator has the A inputs (read) connected to the second read-only port address and the W inputs (write) shared with the first read/write port

synchronously. The sequence can also be paused at any stage, until lock has been achieved on any or all DCMs, as well as DCI.

## Readback

In this mode, configuration data from the Virtex-II Pro FPGA device can be read back. Readback is supported only in the SelectMAP (master and slave) and Boundary-Scan mode.

Along with the configuration data, it is possible to read back the contents of all registers, distributed SelectRAM+, and block RAM resources. This capability is used for real-time debugging. For more detailed configuration information, see the *Virtex-II Pro Platform FPGA User Guide*.

## Bitstream Encryption

Virtex-II Pro devices have an on-chip decryptor using one or two sets of three keys for triple-key Data Encryption Standard (DES) operation. Xilinx software tools offer an optional encryption of the configuration data (bitstream) with a triple-key DES determined by the designer.

The keys are stored in the FPGA by JTAG instruction and retained by a battery connected to the V<sub>BATT</sub> pin, when the device is not powered. Virtex-II Pro devices can be config-

ured with the corresponding encrypted bitstream, using any of the configuration modes described previously.

A detailed description of how to use bitstream encryption is provided in the [Virtex-II Pro Platform FPGA User Guide](#). Your local FAE can also provide specific information on this feature.

## Partial Reconfiguration

Partial reconfiguration of Virtex-II Pro devices can be accomplished in either Slave SelectMAP mode or Boundary-Scan mode. Instead of resetting the chip and doing a full configuration, new data is loaded into a specified area of the chip, while the rest of the chip remains in operation. Data is loaded on a column basis, with the smallest load unit being a configuration “frame” of the bitstream (device size dependent).

Partial reconfiguration is useful for applications that require different designs to be loaded into the same area of a chip, or that require the ability to change portions of a design without having to reset or reconfigure the entire chip.

For more information on Partial Reconfiguration in Virtex-II Pro devices, please refer to Xilinx Application Note [XAPP290, Two Flows for Partial Reconfiguration](#).

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## Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
01/31/02	1.0	Initial Xilinx release.
06/13/02	2.0	New Virtex-II Pro family members. New timing parameters per speedsfile <b>v1.62</b> .
09/03/02	2.1	<ul style="list-style-type: none"> <li>Revised <a href="#">Reset</a> and <a href="#">Power</a> sections.</li> <li>Updated <a href="#">Table 8</a>, which lists compatible input standards. [Table deleted in v2.6.]</li> <li>Added <a href="#">Figure 28</a>, <a href="#">Figure 29</a>, and <a href="#">Figure 30</a>, which provide examples illustrating the use of I/O standards.</li> </ul>
09/27/02	2.2	<ul style="list-style-type: none"> <li>In section <a href="#">RocketIO Overview</a>, corrected max number of MGTs from 16 to 24.</li> <li>In section <a href="#">Input/Output Blocks (IOBs)</a>, added references to XAPP653 regarding implementation of 3.3V I/O standards.</li> </ul>
11/20/02	2.3	<ul style="list-style-type: none"> <li><a href="#">Table 8</a>: Added rows for LVTTL, LVCMS33, and PCI-X.</li> <li><a href="#">Table 8</a>: Added LVTTL and LVCMS33 to compatible 3.3V cells. [Table deleted in v2.6.]</li> <li><a href="#">Table 33</a>: Correct bitstream lengths.</li> </ul>
12/03/02	2.4	<ul style="list-style-type: none"> <li>Added mention of LVTTL and PCI with respect to SelectIO-Ultra configurations. See section <a href="#">Input/Output Individual Options</a> and <a href="#">Figure 22</a>.</li> </ul>
01/20/03	2.5	<ul style="list-style-type: none"> <li>Added qualification to features vs. Virtex-II (open-drain output pin TDO does not have internal pull-up resistor)</li> <li>Table 7: Added HSTL18 (I, II, III, &amp; IV) and HSTL18_DCI (I,II, III &amp; IV) to 1.8V VCCO row. [Table deleted in v2.6.]</li> <li>Table 8: Numerous revisions. [Table deleted in v2.6.]</li> </ul>



# Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Pinout Information

DS083 (v5.0) June 21, 2011

Product Specification

This document provides Virtex™-II Pro Device/Package Combinations, Maximum I/Os, and Virtex-II Pro Pin Definitions, followed by pinout tables, for these packages:

- FG256/FGG256 Fine-Pitch BGA Package
- FG456/FGG456 Fine-Pitch BGA Package
- FG676/FGG676 Fine-Pitch BGA Package
- FF672 Flip-Chip Fine-Pitch BGA Package
- FF896 Flip-Chip Fine-Pitch BGA Package

- FF1152 Flip-Chip Fine-Pitch BGA Package
- FF1148 Flip-Chip Fine-Pitch BGA Package
- FF1517 Flip-Chip Fine-Pitch BGA Package
- FF1704 Flip-Chip Fine-Pitch BGA Package
- FF1696 Flip-Chip Fine-Pitch BGA Package

For device pinout diagrams and layout guidelines, refer to the [Virtex-II Pro Platform FPGA User Guide](#). ASCII package pinout files are also available for download from the Xilinx website ([www.xilinx.com](http://www.xilinx.com)).

## Virtex-II Pro Device/Package Combinations and Maximum I/Os<sup>(1)</sup>

Wire-bond and flip-chip packages are available. [Table 1](#) and [Table 2](#) show the maximum number of user I/Os possible in wire-bond and flip-chip packages, respectively.

- FG denotes wire-bond fine-pitch BGA (1.00 mm pitch).
- FGG denotes Pb-free wire-bond fine-pitch BGA (1.00 mm pitch).
- FF denotes flip-chip fine-pitch BGA (1.00 mm pitch)

*Table 1: Wire-Bond Packages Information*

Package <sup>(1)</sup>	FG256/ FGG256	FG456/ FGG456	FG676/ FGG676
Pitch (mm)	1.00	1.00	1.00
Size (mm)	17 x 17	23 x 23	26 x 26
Maximum I/Os	140	248	412

**Notes:**

1. Wire-bond packages include FGG<sub>n</sub>nn Pb-free versions. See [Virtex-II Pro Ordering Examples \(Module 1\)](#).

*Table 2: Flip-Chip Packages Information*

Package	FF672	FF896	FF1152	FF1148	FF1517	FF1704	FF1696
Pitch (mm)	1.00	1.00	1.00	1.00	1.00	1.00	1.00
Size (mm)	27 x 27	31 x 31	35 x 35	35 x 35	40 x 40	42.5 x 42.5	42.5 x 42.5
Maximum I/Os	396	556	644	812	964	1040	1200

[Table 3](#) shows the number of available I/Os, the number of RocketIO™ (or RocketIO X) multi-gigabit transceiver (MGT) pins, and the number of differential I/O pairs for each Virtex-II Pro device/package combination. The number of I/Os per package includes all user I/Os *except* the fifteen control pins (CCLK, DONE, M0, M1, M2, PROG\_B, PWRDWN\_B, TCK, TDI, TDO, TMS, HSWAP\_EN, DXN, DXP, and RSVD), the nine (per transceiver) RocketIO MGT pins (TXP, TXN, RXP, RXN, AVCCAUXTX, AVCCAUXRX, VTTX, VTRX, and GNDA), and for Virtex-II Pro X devices only, the two BREFCLKN/BREFCLKP differential clock input pairs (four pins). The Virtex-II Pro X devices are highlighted in bold type.

1. Unless otherwise noted, "Virtex-II Pro" refers to members of the Virtex-II Pro and/or Virtex-II Pro X families.

Table 6: FG456/FGG456 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
6	IO_L06N_6	V1			
6	IO_L43P_6	U4	NC		
6	IO_L43N_6	U3	NC		
6	IO_L45P_6	U2	NC		
6	IO_L45N_6/VREF_6	U1	NC		
6	IO_L47P_6	U5	NC		
6	IO_L47N_6	T5	NC		
6	IO_L48P_6	T4	NC		
6	IO_L48N_6	T3	NC		
6	IO_L49P_6	T2	NC		
6	IO_L49N_6	T1	NC		
6	IO_L51P_6	R4	NC		
6	IO_L51N_6/VREF_6	R3	NC		
6	IO_L53P_6	R2	NC		
6	IO_L53N_6	R1	NC		
6	IO_L54P_6	R5	NC		
6	IO_L54N_6	P6	NC		
6	IO_L55P_6	P4	NC		
6	IO_L55N_6	P3	NC		
6	IO_L57P_6	P2	NC		
6	IO_L57N_6/VREF_6	P1	NC		
6	IO_L59P_6	P5	NC		
6	IO_L59N_6	N5	NC		
6	IO_L60P_6	N4	NC		
6	IO_L60N_6	N3	NC		
6	IO_L85P_6	N2			
6	IO_L85N_6	N1			
6	IO_L87P_6	N6			
6	IO_L87N_6/VREF_6	M6			
6	IO_L89P_6	M5			
6	IO_L89N_6	M4			
6	IO_L90P_6	M3			
6	IO_L90N_6	M2			
7	IO_L90P_7	L2			
7	IO_L90N_7	L3			
7	IO_L88P_7	L4			

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
7	IO_L52P_7	M7			
7	IO_L52N_7/VREF_7	L7			
7	IO_L50P_7	K1			
7	IO_L50N_7	K2			
7	IO_L49P_7	L3			
7	IO_L49N_7	K3			
7	IO_L48P_7	K4			
7	IO_L48N_7	K5			
7	IO_L46P_7	L8			
7	IO_L46N_7/VREF_7	K8			
7	IO_L44P_7	J1			
7	IO_L44N_7	J2			
7	IO_L43P_7	J3			
7	IO_L43N_7	J4			
7	IO_L42P_7	J5			
7	IO_L42N_7	J6			
7	IO_L40P_7	J7			
7	IO_L40N_7/VREF_7	J8			
7	IO_L38P_7	H1			
7	IO_L38N_7	H2			
7	IO_L37P_7	H6			
7	IO_L37N_7	H7			
7	IO_L36P_7	G1			
7	IO_L36N_7	G2			
7	IO_L34P_7	G3			
7	IO_L34N_7/VREF_7	G4			
7	IO_L32P_7	H5			
7	IO_L32N_7	G5			
7	IO_L31P_7	F1			
7	IO_L31N_7	F2			
7	IO_L24P_7	F3	NC		
7	IO_L24N_7	F4	NC		
7	IO_L06P_7	G6			
7	IO_L06N_7	F6			
7	IO_L04P_7	E1			

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
6	IO_L02P_6		AH26			
6	IO_L02N_6		AG26			
6	IO_L03P_6		AH29			
6	IO_L03N_6/VREF_6		AH30			
6	IO_L04P_6		AH27			
6	IO_L04N_6		AG28			
6	IO_L05P_6		AD25			
6	IO_L05N_6		AD26			
6	IO_L06P_6		AG29			
6	IO_L06N_6		AG30			
6	IO_L31P_6		AF25	NC		
6	IO_L31N_6		AE26	NC		
6	IO_L32P_6		AB23	NC		
6	IO_L32N_6		AB24	NC		
6	IO_L33P_6		AE27	NC		
6	IO_L33N_6/VREF_6		AE28	NC		
6	IO_L34P_6		AF27	NC		
6	IO_L34N_6		AF28	NC		
6	IO_L35P_6		AC25	NC		
6	IO_L35N_6		AC26	NC		
6	IO_L36P_6		AF29	NC		
6	IO_L36N_6		AF30	NC		
6	IO_L37P_6		AD27	NC		
6	IO_L37N_6		AD28	NC		
6	IO_L38P_6		AA23	NC		
6	IO_L38N_6		AA24	NC		
6	IO_L39P_6		AE29	NC		
6	IO_L39N_6/VREF_6		AE30	NC		
6	IO_L40P_6		AB25	NC		
6	IO_L40N_6		AB26	NC		
6	IO_L41P_6		Y23	NC		
6	IO_L41N_6		Y24	NC		
6	IO_L42P_6		AD29	NC		
6	IO_L42N_6		AD30	NC		
6	IO_L43P_6		AC27			
6	IO_L43N_6		AC28			

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	IO_L18N_7	L25	NC			
7	IO_L17P_7	F34	NC			
7	IO_L17N_7	F33	NC			
7	IO_L16P_7	G30	NC			
7	IO_L16N_7/VREF_7	G29	NC			
7	IO_L15P_7	G32	NC			
7	IO_L15N_7	G31	NC			
7	IO_L06P_7	F31				
7	IO_L06N_7	F30				
7	IO_L05P_7	J28				
7	IO_L05N_7	J27				
7	IO_L04P_7	E34				
7	IO_L04N_7/VREF_7	E33				
7	IO_L03P_7	E32				
7	IO_L03N_7	E31				
7	IO_L02P_7	F28				
7	IO_L02N_7	F27				
7	IO_L01P_7/VRN_7	D34				
7	IO_L01N_7/VRP_7	D33				
0	VCCO_0	C29				
0	VCCO_0	E20				
0	VCCO_0	F25				
0	VCCO_0	L20				
0	VCCO_0	L21				
0	VCCO_0	L22				
0	VCCO_0	L23				
0	VCCO_0	M18				
0	VCCO_0	M19				
0	VCCO_0	M20				
0	VCCO_0	M21				
0	VCCO_0	M22				
1	VCCO_1	C6				
1	VCCO_1	E15				
1	VCCO_1	F10				
1	VCCO_1	L12				
1	VCCO_1	L13				
1	VCCO_1	L14				

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
N/A	GND	AG8				
N/A	GND	AG12				
N/A	GND	AG15				
N/A	GND	AG20				
N/A	GND	AG23				
N/A	GND	AG27				
N/A	GND	J34				
N/A	GND	AH7				
N/A	GND	AH28				
N/A	GND	AJ6				
N/A	GND	AJ29				
N/A	GND	AK5				
N/A	GND	AK12				
N/A	GND	AK23				
N/A	GND	AK30				
N/A	GND	AL4				
N/A	GND	AL31				
N/A	GND	AM1				
N/A	GND	AM2				
N/A	GND	AM10				
N/A	GND	AM16				
N/A	GND	AM19				
N/A	GND	AM25				
N/A	GND	AM33				
N/A	GND	AM34				
N/A	GND	AN1				
N/A	GND	AN34				

**Notes:**

- See Table 4 for an explanation of the signals available on this pin.

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
2	IO_L02P_2	D9		
2	IO_L03N_2	B7		
2	IO_L03P_2	A7		
2	IO_L04N_2/VREF_2	B6		
2	IO_L04P_2	A6		
2	IO_L05N_2	E8		
2	IO_L05P_2	D8		
2	IO_L06N_2	B4		
2	IO_L06P_2	A4		
2	IO_L07N_2	B3		
2	IO_L07P_2	A3		
2	IO_L08N_2	H7		
2	IO_L08P_2	H8		
2	IO_L09N_2	C6		
2	IO_L09P_2	C7		
2	IO_L10N_2/VREF_2	C5		
2	IO_L10P_2	B5		
2	IO_L11N_2	K8		
2	IO_L11P_2	J8		
2	IO_L12N_2	C1		
2	IO_L12P_2	C2		
2	IO_L13N_2	E7		
2	IO_L13P_2	D7		
2	IO_L14N_2	J6		
2	IO_L14P_2	J7		
2	IO_L15N_2	D5		
2	IO_L15P_2	D6		
2	IO_L16N_2/VREF_2	E4		
2	IO_L16P_2	D4		
2	IO_L17N_2	L9		
2	IO_L17P_2	K9		
2	IO_L18N_2	E3		
2	IO_L18P_2	D3		
2	IO_L19N_2	D1		
2	IO_L19P_2	D2		
2	IO_L20N_2	K7		
2	IO_L20P_2	L7		
2	IO_L21N_2	F6		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
5	IO_L27P_5	AL23		
5	IO_L26N_5	AD22		
5	IO_L26P_5	AE22		
5	IO_L25N_5	AJ23		
5	IO_L25P_5	AK23		
5	IO_L21N_5	AN24		
5	IO_L21P_5	AP24		
5	IO_L20N_5	AE23		
5	IO_L20P_5	AF23		
5	IO_L19N_5	AM23		
5	IO_L19P_5	AM24		
5	IO_L09N_5/VREF_5	AJ24		
5	IO_L09P_5	AK24		
5	IO_L08N_5	AG22		
5	IO_L08P_5	AG23		
5	IO_L07N_5/VREF_5	AH23		
5	IO_L07P_5	AH24		
5	IO_L06N_5/VRP_5	AN25		
5	IO_L06P_5/VRN_5	AP25		
5	IO_L05_5/No_Pair	AH25		
5	IO_L03N_5/D4	AL25		
5	IO_L03P_5/D5	AM25		
5	IO_L02N_5/D6	AE24		
5	IO_L02P_5/D7	AF24		
5	IO_L01N_5/RDWR_B	AJ25		
5	IO_L01P_5/CS_B	AK25		
6	IO_L01P_6/VRN_6	AP32		
6	IO_L01N_6/VRP_6	AN32		
6	IO_L02P_6	AP28		
6	IO_L02N_6	AN28		
6	IO_L03P_6	AP31		
6	IO_L03N_6/VREF_6	AN31		
6	IO_L04P_6	AP29		
6	IO_L04N_6	AN29		
6	IO_L05P_6	AN26		
6	IO_L05N_6	AN27		
6	IO_L06P_6	AM33		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	VCCINT	M12		
N/A	VCCINT	AD11		
N/A	VCCINT	L11		
N/A	VCCAUX	AN34		
N/A	VCCAUX	AG34		
N/A	VCCAUX	U34		
N/A	VCCAUX	H34		
N/A	VCCAUX	B34		
N/A	VCCAUX	AP33		
N/A	VCCAUX	A33		
N/A	VCCAUX	AP27		
N/A	VCCAUX	A27		
N/A	VCCAUX	AP17		
N/A	VCCAUX	A17		
N/A	VCCAUX	AP8		
N/A	VCCAUX	A8		
N/A	VCCAUX	AP2		
N/A	VCCAUX	A2		
N/A	VCCAUX	AN1		
N/A	VCCAUX	AG1		
N/A	VCCAUX	U1		
N/A	VCCAUX	H1		
N/A	VCCAUX	B1		
N/A	GND	AK34		
N/A	GND	AF34		
N/A	GND	AB34		
N/A	GND	W34		
N/A	GND	V34		
N/A	GND	T34		
N/A	GND	N34		
N/A	GND	J34		
N/A	GND	E34		
N/A	GND	AN33		
N/A	GND	B33		
N/A	GND	AM32		
N/A	GND	C32		
N/A	GND	AP30		
N/A	GND	AK30		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
2	IO_L11N_2	L9		
2	IO_L11P_2	M10		
2	IO_L12N_2	H4		
2	IO_L12P_2	J5		
2	IO_L13N_2	J1		
2	IO_L13P_2	J2		
2	IO_L14N_2	M8		
2	IO_L14P_2	N9		
2	IO_L15N_2	K6		
2	IO_L15P_2	K7		
2	IO_L16N_2/VREF_2	K4		
2	IO_L16P_2	K5		
2	IO_L17N_2	P10		
2	IO_L17P_2	N10		
2	IO_L18N_2	K3		
2	IO_L18P_2	J3		
2	IO_L19N_2	K1		
2	IO_L19P_2	K2		
2	IO_L20N_2	M11		
2	IO_L20P_2	N11		
2	IO_L21N_2	L7		
2	IO_L21P_2	L8		
2	IO_L22N_2/VREF_2	L5		
2	IO_L22P_2	L6		
2	IO_L23N_2	P8		
2	IO_L23P_2	P9		
2	IO_L24N_2	L3		
2	IO_L24P_2	L4		
2	IO_L25N_2	L1		
2	IO_L25P_2	L2		
2	IO_L26N_2	P11		
2	IO_L26P_2	P12		
2	IO_L27N_2	M6		
2	IO_L27P_2	M7		
2	IO_L28N_2/VREF_2	M2		
2	IO_L28P_2	M3		
2	IO_L29N_2	R9		
2	IO_L29P_2	R10		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
3	IO_L47P_3	AC10		
3	IO_L46N_3	AE7		
3	IO_L46P_3	AE8		
3	IO_L45N_3/VREF_3	AE5		
3	IO_L45P_3	AE6		
3	IO_L44N_3	AB13		
3	IO_L44P_3	AC13		
3	IO_L43N_3	AE3		
3	IO_L43P_3	AE4		
3	IO_L42N_3	AE1		
3	IO_L42P_3	AE2		
3	IO_L41N_3	AD10		
3	IO_L41P_3	AD11		
3	IO_L40N_3	AF6		
3	IO_L40P_3	AF7		
3	IO_L39N_3/VREF_3	AF4		
3	IO_L39P_3	AF5		
3	IO_L38N_3	AC12		
3	IO_L38P_3	AD12		
3	IO_L37N_3	AF1		
3	IO_L37P_3	AF2		
3	IO_L36N_3	AG6		
3	IO_L36P_3	AG7		
3	IO_L35N_3	AE9		
3	IO_L35P_3	AE10		
3	IO_L34N_3	AF3		
3	IO_L34P_3	AG3		
3	IO_L33N_3/VREF_3	AG1		
3	IO_L33P_3	AG2		
3	IO_L32N_3	AE11		
3	IO_L32P_3	AE12		
3	IO_L31N_3	AH6		
3	IO_L31P_3	AH7		
3	IO_L30N_3	AG5		
3	IO_L30P_3	AH4		
3	IO_L29N_3	AD13		
3	IO_L29P_3	AE13		
3	IO_L28N_3	AH2		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
6	IO_L34P_6	AG37		
6	IO_L34N_6	AF37		
6	IO_L35P_6	AE30		
6	IO_L35N_6	AE31		
6	IO_L36P_6	AG33		
6	IO_L36N_6	AG34		
6	IO_L37P_6	AF38		
6	IO_L37N_6	AF39		
6	IO_L38P_6	AD28		
6	IO_L38N_6	AC28		
6	IO_L39P_6	AF35		
6	IO_L39N_6/VREF_6	AF36		
6	IO_L40P_6	AF33		
6	IO_L40N_6	AF34		
6	IO_L41P_6	AD29		
6	IO_L41N_6	AD30		
6	IO_L42P_6	AE38		
6	IO_L42N_6	AE39		
6	IO_L43P_6	AE36		
6	IO_L43N_6	AE37		
6	IO_L44P_6	AC27		
6	IO_L44N_6	AB27		
6	IO_L45P_6	AE34		
6	IO_L45N_6/VREF_6	AE35		
6	IO_L46P_6	AE32		
6	IO_L46N_6	AE33		
6	IO_L47P_6	AC30		
6	IO_L47N_6	AC31		
6	IO_L48P_6	AD37		
6	IO_L48N_6	AD38		
6	IO_L49P_6	AD33		
6	IO_L49N_6	AD34		
6	IO_L50P_6	AB28		
6	IO_L50N_6	AB29		
6	IO_L51P_6	AD36		
6	IO_L51N_6/VREF_6	AC36		
6	IO_L52P_6	AD32		
6	IO_L52N_6	AC32		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
2	IO_L44P_2		U10		
2	IO_L45N_2		U3		
2	IO_L45P_2		U4		
2	IO_L46N_2/VREF_2		U1		
2	IO_L46P_2		U2		
2	IO_L47N_2		T12		
2	IO_L47P_2		U12		
2	IO_L48N_2		V10		
2	IO_L48P_2		V11		
2	IO_L49N_2		V7		
2	IO_L49P_2		V8		
2	IO_L50N_2		U11		
2	IO_L50P_2		V12		
2	IO_L51N_2		V4		
2	IO_L51P_2		V5		
2	IO_L52N_2/VREF_2		V1		
2	IO_L52P_2		V2		
2	IO_L53N_2		W9		
2	IO_L53P_2		W10		
2	IO_L54N_2		W7		
2	IO_L54P_2		W8		
2	IO_L55N_2		W5		
2	IO_L55P_2		W6		
2	IO_L56N_2		W11		
2	IO_L56P_2		W12		
2	IO_L57N_2		W3		
2	IO_L57P_2		W4		
2	IO_L58N_2/VREF_2		W1		
2	IO_L58P_2		W2		
2	IO_L59N_2		Y9		
2	IO_L59P_2		Y10		
2	IO_L60N_2		Y6		
2	IO_L60P_2		Y7		
2	IO_L85N_2		Y3		
2	IO_L85P_2		Y4		
2	IO_L86N_2		Y11		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L27P_7		P33		
7	IO_L27N_7		P34		
7	IO_L26P_7		N31		
7	IO_L26N_7		N32		
7	IO_L25P_7		N41		
7	IO_L25N_7		N42		
7	IO_L24P_7		N39		
7	IO_L24N_7		N40		
7	IO_L23P_7		N33		
7	IO_L23N_7		N34		
7	IO_L22P_7		N37		
7	IO_L22N_7/VREF_7		N38		
7	IO_L21P_7		N35		
7	IO_L21N_7		N36		
7	IO_L20P_7		M38		
7	IO_L20N_7		M39		
7	IO_L19P_7		M40		
7	IO_L19N_7		M41		
7	IO_L18P_7		M33		
7	IO_L18N_7		M34		
7	IO_L17P_7		M31		
7	IO_L17N_7		M32		
7	IO_L16P_7		M35		
7	IO_L16N_7/VREF_7		M36		
7	IO_L15P_7		L41		
7	IO_L15N_7		L42		
7	IO_L14P_7		L39		
7	IO_L14N_7		L38		
7	IO_L13P_7		L40		
7	IO_L13N_7		K40		
7	IO_L12P_7		L36		
7	IO_L12N_7		L37		
7	IO_L11P_7		L34		
7	IO_L11N_7		L35		
7	IO_L10P_7		K42		
7	IO_L10N_7/VREF_7		K41		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
1	IO_L87N_1/VREF_1	C15	
1	IO_L87P_1	C16	
1	IO_L86N_1	K15	
1	IO_L86P_1	J15	
1	IO_L85N_1	F15	
1	IO_L85P_1	E15	
1	IO_L84N_1	G15	
1	IO_L84P_1	G16	
1	IO_L83_1/No_Pair	M15	
1	IO_L80_1/No_Pair	L15	
1	IO_L79N_1	B14	
1	IO_L79P_1	A14	
1	IO_L78N_1	C14	
1	IO_L78P_1	D15	
1	IO_L77N_1	K14	
1	IO_L77P_1	J14	
1	IO_L76N_1	F14	
1	IO_L76P_1	E14	
1	IO_L36N_1/VREF_1	G14	
1	IO_L36P_1	H15	
1	IO_L35N_1	M14	
1	IO_L35P_1	L14	
1	IO_L34N_1	C13	
1	IO_L34P_1	B13	
1	IO_L30N_1	G13	
1	IO_L30P_1	F13	
1	IO_L29N_1	L13	
1	IO_L29P_1	K13	
1	IO_L28N_1	C12	
1	IO_L28P_1	B12	
1	IO_L27N_1/VREF_1	D12	
1	IO_L27P_1	D13	
1	IO_L26N_1	J12	
1	IO_L26P_1	H12	
1	IO_L25N_1	F12	
1	IO_L25P_1	E12	
1	IO_L21N_1	G12	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
2	IO_L59N_2	AA11	
2	IO_L59P_2	AA12	
2	IO_L60N_2	W1	
2	IO_L60P_2	W2	
2	IO_L85N_2	Y2	
2	IO_L85P_2	Y3	
2	IO_L86N_2	AA9	
2	IO_L86P_2	AA10	
2	IO_L87N_2	AA5	
2	IO_L87P_2	AA6	
2	IO_L88N_2/VREF_2	AA4	
2	IO_L88P_2	Y4	
2	IO_L89N_2	AA7	
2	IO_L89P_2	AA8	
2	IO_L90N_2	AA2	
2	IO_L90P_2	AA3	
3	IO_L90N_3	AB5	
3	IO_L90P_3	AB6	
3	IO_L89N_3	AB11	
3	IO_L89P_3	AB12	
3	IO_L88N_3	AB2	
3	IO_L88P_3	AB3	
3	IO_L87N_3/VREF_3	AB4	
3	IO_L87P_3	AC4	
3	IO_L86N_3	AB9	
3	IO_L86P_3	AB10	
3	IO_L85N_3	AC2	
3	IO_L85P_3	AC3	
3	IO_L60N_3	AD5	
3	IO_L60P_3	AD6	
3	IO_L59N_3	AB7	
3	IO_L59P_3	AB8	
3	IO_L58N_3	AD1	
3	IO_L58P_3	AD2	
3	IO_L57N_3/VREF_3	AE4	
3	IO_L57P_3	AE5	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
N/A	GND	BB34	
N/A	GND	AV34	
N/A	GND	AP34	
N/A	GND	AK34	
N/A	GND	AF34	
N/A	GND	AC34	
N/A	GND	Y34	
N/A	GND	U34	
N/A	GND	N34	
N/A	GND	J34	
N/A	GND	E34	
N/A	GND	A34	
N/A	GND	AD31	
N/A	GND	W31	
N/A	GND	BB30	
N/A	GND	AV30	
N/A	GND	AP30	
N/A	GND	J30	
N/A	GND	E30	
N/A	GND	A30	
N/A	GND	BB26	
N/A	GND	AV26	
N/A	GND	AP26	
N/A	GND	AE26	
N/A	GND	AD26	
N/A	GND	AC26	
N/A	GND	AB26	
N/A	GND	AA26	
N/A	GND	Y26	
N/A	GND	W26	
N/A	GND	V26	
N/A	GND	J26	
N/A	GND	E26	
N/A	GND	A26	
N/A	GND	AF25	
N/A	GND	AE25	
N/A	GND	AD25	